

MCP1601 Evaluation Board User's Guide

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General Information

INTRODUCTION AND HIGHLIGHTS

This section contains general information that will be useful to know before using the MCP1601 Evaluation Board.

This section covers the following topics:

- · About this Guide
- · Recommended Reading
- · The Microchip Internet Web Site
- Customer Support

ABOUT THIS GUIDE

Document Layout

This document describes how to use the MCP1601 Evaluation Board.

The User's Guide layout is as follows:

• Chapter 1: MCP1601 Evaluation Board - For user's evaluating the MCP1601 device, this section describes how to use the various features of the board.

Appendices

- Appendix A: Schematic and Board Layout shows the schematic and Printed Circuit Board (PCB) layout diagrams for the MCP1601 Evaluation Board.
 - Appendix A.1 gives some overview and highlight information.
 - Appendix A.2 contains the Evaluation Board Schematic
 - Appendix A.3 shows the Silk Screen Layer of the PCB.
 - Appendix A.4 shows the Silk Screen and Top Metal Layer of the PCB.
 - Appendix A.5 shows the Silk Screen and Bottom Metal layer of the PCB.
- Appendix B: Bill of Materials Table B-1 shows the Bill of Materials (BOM) for the PCB.
- Worldwide Sales and Service gives the address, telephone and fax number for Microchip Technology Inc. sales and service locations throughout the world.

Recommended Reading

For more information regarding the MCP1601 device, the following is recommended reading:

MCP1601 Data Sheet (DS21762)

This data sheet provides detailed information regarding the MCP1601 500 mA Synchronous BUCK Regulator. The data sheet is available for download from our World Wide Web Site (www.microchip.com) or from the Technical Library CD-ROM (DS00161).

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- · Corporate Applications Engineer (CAE)
- · Hot line

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Corporate Applications Engineers (CAEs) may be contacted at (480) 792-7627.

In addition, there is a Systems Information and Upgrade Line. This line provides system users a listing of the latest versions of all of Microchip's development systems software products. Plus, this line provides information on how customers can receive any currently available upgrade kits.

The Hot Line Numbers are:

- 1-800-755-2345 for U.S. and most of Canada, and
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Chapter 1. MCP1601 Evaluation Board

1.1 INTRODUCTION

The MCP1601 Evaluation Board is designed to demonstrate the use of the MCP1601 Synchronous BUCK Regulator in a step down, inductor-based DC/DC converter application. It also describes the capability of the MCP1601 Evaluation Board and how to select the desired Synchronous Converter operating mode and program the output voltage.

The Evaluation Board Schematic is shown is Figure 1-1.

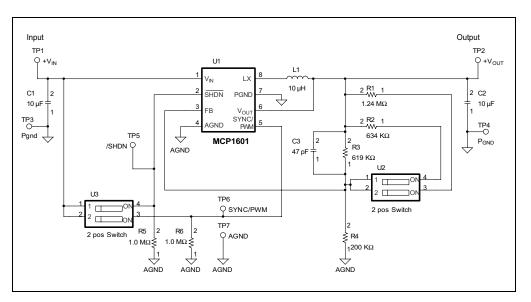


FIGURE 1-1: MCP1601 Evaluation Board Schematic.

1.2 DETAILED DESCRIPTION

The MCP1601 is a 500 mA Synchronous BUCK Regulator. Both the high-side BUCK P-Channel and the low-side N-Channel switches are integrated within the device. The integrated synchronous switch makes the MCP1601 very efficient, even when converting unregulated input voltages to low voltage fixed outputs. This evaluation board is designed for a wide range of output voltages and currents. For specific applications, smaller inductors, shielded inductors, tantalum capacitors and different output voltage settings can improve the total DC/DC converter performance and cost.

The MCP1601 device can operate in three different modes of operation to optimize the efficiency of the voltage conversion. The three operating modes are:

- Automatic switching from PFM Mode to PWM mode and back
- Synchronization to external Oscillator
- · Fixed Frequency Forced PWM Mode

The MCP1601 output voltage is adjustable and is set by two external divider resistors. A two-position switch is used on the MCP1601 Evaluation Board to change the resistance of the external divider and adjust the output voltage to four different settings. These output voltage settings are: 1.8V, 2.05V, 2.45V and 3.28V.

1.2.1 Applying Power to the Board

Two surface mount test points are used to apply power to the MCP1601 Evaluation Board. For proper operation, the input voltage range is $2.7V < +V_{\text{IN}} < +5.5V$ for all operating conditions. The MCP1601 has an internal Under-Voltage Lockout (UVLO) which will prevent the board from operating when the input voltage is below the specified 2.7V minimum.

- Connect the positive side of the external power supply (+) to the +V_{IN} test point.
- 2. Connect the negative side (GND) of the external power supply to the P_{GND} test point which is located directly below the + V_{IN} test point.

1.2.2 Connecting a Load to the Board

To connect an external load to the board, the +V_{OUT} and P_{GND} test points are used.

Connect the positive side of the load to the +V_{OUT} pin and the negative or ground side of the load to the P_{GND} test point located directly under the +V_{OUT} test point. The MCP1601 output is rated for 500 mA (maximum) continuous current. The output is protected against over current and short circuit conditions.

1.2.3 Enabling the MCP1601 - Using Switch U₃, Position 1

Switch U_3 , position 1 is used to determine the \overline{SHDN} mode for the MCP1601 device. With switch U_3 , position 1 pushed to the right, the \overline{SHDN} pin is pulled up and the output of the MCP1601 device is enabled. When switch U_3 , position 1 is to the left, the MCP1601 device is in a low quiescent current \overline{SHDN} mode and the output is disabled.

1.2.4 Selecting the Operating Mode - Using Switch U3, Position 2

The multi-function SYNC/PWM pin on the MCP1601 is used to set the operating mode of the device. The three operating modes are:

- Automatic switching from PFM Mode to PWM mode and back
- · Synchronization to external Oscillator
- Fixed Frequency Forced PWM Mode

To select automatic PFM/PWM mode:

 Slide switch U₃, position 2 to the left or off position. While operating in this mode, the MCP1601 device will automatically select the most efficient operating mode by approximating the load current internally.

To synchronize the MCP1601 switching frequency to an external oscillator:

 Slide switch U₃, position 2 to the left. Connect the external oscillator to the SYNC/PWM test point located directly below switch U₃ and the A_{GND} test point. See the MCP1601 datasheet (DS21762) for external clock specifications. When synchronizing to an external oscillator, the MCP1601 will operate in the fixed frequency mode at the same frequency as the external oscillator.

To select fixed frequency mode that operates off of the 750 kHz internal oscillator:

Slide switch U₃, position 2 to the right or "on" position. This will tie the SYNC/PWM pin high and force PWM operation from the internal oscillator, making the MCP1601 device independent of external load conditions.

1.2.5 Selecting the MCP1601 output voltage

Switch U_2 is used to select the output voltage. Refer to Table 1-1 to choose one of the pre-selected output voltages.

TABLE 1-1: SWITCH SETTINGS FOR PRE-SELECTED OUTPUT VOLTAGES

U2, Position 1	U2, Position 2	V _{OUT}	
OFF	OFF	3.28V	
OFF	ON	2.45V	
ON	OFF	2.05V	
ON	ON	1.8	

The output voltage for the MCP1601 device is determined by using the following formula.

EQUATION

$$V_{OUT} = V_{REF} \left(1 + \frac{R_2}{R_4} \right)$$

Where: $V_{RFF} = 0.8V$ Typical

 R_4 = 200 k Ω for the Evaluation board

 R_2 is set by the parallel combination of R_1 , R_2 and R_3 .

1.3 TEST POINTS

1.3.1 /SHDN

The /SHDN or shutdown test point can be used to monitor the level of the shutdown pin or as an input to the shutdown pin of the MCP1601 device. With switch U_3 , position 1 in the "off" position, a 1 M Ω resistor will pull the pin low.

1.3.2 SYNC/PWM

The SYNC/PWM pin can be used to monitor the level of the SYNC/PWM pin or as an input to the MCP1601 device. With switch $\rm U_3$, position 2 in the "off" position, a 1 M Ω resistor will pull the pin low.

To synchronize to an external oscillator:

 With switch U₃, position 2 in the off position, connect the external oscillator to the SYNC/PWM test point.

1.3.3 **A**_{GND}

The analog ground or A_{GND} can be used as a quiet ground connection. When using the external oscillator synchronization function, connect the return or ground of the external oscillator to the A_{GND} test point.



Appendix A. Schematic and Board Layouts

A.1 INTRODUCTION

This appendix contains the schematic and board layout diagrams for the MCP1601 Evaluation Board.

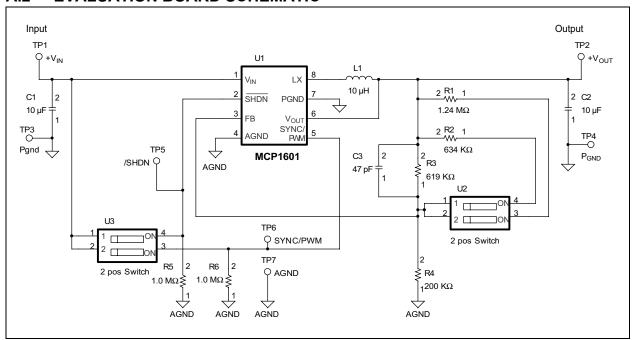
A.1.1 Highlights

The MCP1601 Evaluation Board is constructed using one (1) silk screen layer and two (2) 1 oz. metal wiring layers. The bottom metal wiring layer is a single ground plane which is routed to partition the $P_{\mbox{\footnotesize{GND}}}$ high current return pin from the small signal $A_{\mbox{\footnotesize{GND}}}$ return pin on the MCP1601 device.

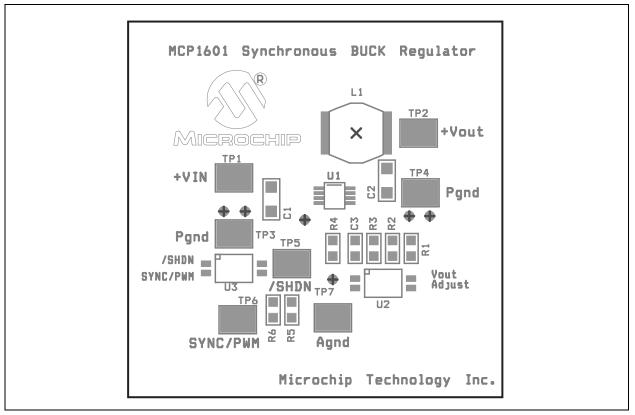
Diagrams included in this appendix:

- Evaluation Board Schematic
- · Evaluation Board Top Silk Screen Layer
- · Evaluation Board Top Metal Layer
- · Evaluation Board Bottom Metal Layer

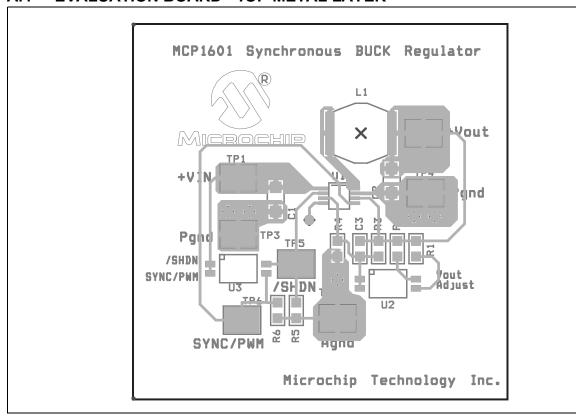
A.2 EVALUATION BOARD SCHEMATIC



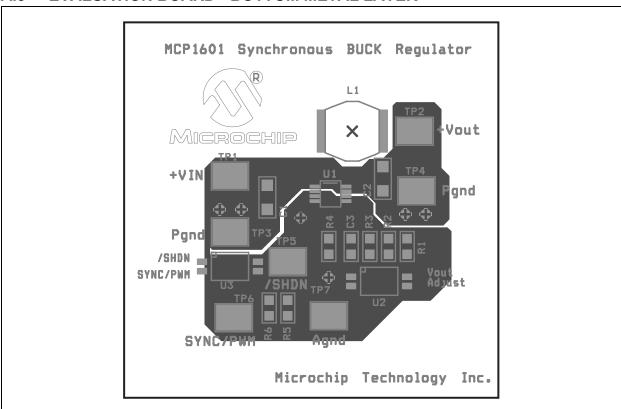
A.3 EVALUATION BOARD - SILK SCREEN LAYER



A.4 EVALUATION BOARD - TOP METAL LAYER



A.5 EVALUATION BOARD - BOTTOM METAL LAYER



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Appendix B. Bill Of Materials (BOM)

TABLE B-1: BILL OF MATERIALS (BOM)

Reference Designator	Qty	Description	Manufacturer	Manufacturer Part Number
R ₁	1	Resistor 1.24 MΩ 1/8W 1% 0805 SMD	Yageo [®]	9C08052A1224FKHFT
R ₂	1	Resistor 634 kΩ 1/10W 1% 0805 SMD	Panasonic [®] - ECG	ERJ-6ENF6343V
R ₃	1	Resistor 619 kΩ 1/10W 1% 0805 SMD	Panasonic [®] - ECG	ERJ-6ENF6193V
R ₄	1	Resistor 200 kΩ 1/10W 1% 0805 SMD	Panasonic [®] - ECG	ERJ-6ENF200V
R ₅ ,R ₆	2	Resistor 1.00 MΩ 1/10W 1% 0805 SMD	Panasonic [®] - ECG	ERJ-6ENF1004V
C ₁ , C ₂	2	Capacitor 10 μF, 6.3V Ceramic X5R 1206 SMD	Kemet [®]	C1206C106K9PACT
C ₃	1	Capacitor 47 pF, 50V Ceramic 0805 SMD	Panasonic [®] - ECG	ECJ-2VC1H470J
L ₁	1	10 μH Coilcraft Wafer Inductor	Coilcraft [®]	LPO2506IB-103
U ₁	1	Microchip Synchronous BUCK Regulator	Microchip Technology Inc.	MCP1601
U ₂ , U ₃	2	DIP Switches, 2-Position, SPST	C&K®	TDA02H0SK1
TP ₁ - TP ₇	7	Test Points	Keystone [®]	5016
	4	Bumpons - Protective Products	3M [®]	SJ5003-0



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